

6A, 100V - 200V Ultra Fast Surface Mount Rectifier

FEATURES

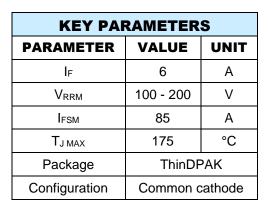
- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

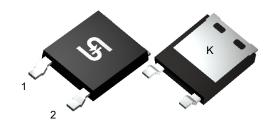
- High frequency switching
- DC/DC
- Snubber

MECHANICAL DATA

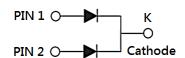
- Case: ThinDPAK
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.192g (approximately)







ThinDPAK



PARAMETER		SYMBOL	PUAD6BCH	PUAD6DCH	UNIT
Marking code on the device			UAD6BC	UAD6DC	
Repetitive peak reverse voltage		V_{RRM}	100	200	V
Reverse voltage, total rms value		V _{R(RMS)}	70	140	V
Forward current per device		l _F	6		Α
Surge peak forward current single half	t = 8.3ms		85 180		- A
sine-wave superimposed on rated load per diode	t = 1.0ms	I _{FSM}			
Junction temperature		TJ	-55 to +175		°C
Storage temperature		Tstg	-55 to +175		°C

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	R _Ð JL	6.3	°C/W	
Junction-to-ambient thermal resistance	Reja	16.9	°C/W	
Junction-to-case thermal resistance	Rejc	3.0	°C/W	

Thermal Performance Note: Mounted on heat sink with 2" x 3" x 0.25" Al-Plate

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	I _F = 1.5A, T _J = 25°C		0.81	-	V
	I _F = 1.5A, T _J = 125°C	\/_	0.66	-	V
	I _F = 3.0A, T _J = 25°C	VF	0.88	0.95	V
	I _F = 3.0A, T _J = 125°C		0.73	-	V
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C		-	2	μA
	T _J = 125°C	l _R	1	-	μA
Junction capacitance per diode	$1MHz, V_R = 4.0V$	Сл	46	-	pF
Davoraa raasvaru tima	I _F = 0.5A, I _R = 1.0A, I _{rr} = 0.25A	4	-	25	ns
Reverse recovery time	$I_F = 1.0A$, $di/dt = 50A/\mu s$, $V_R = 30V$	t _{rr}	25	-	
Reverse recovery current		I _{RM}	3.4	-	Α
Reverse recovery charge	I _F = 3.0A, di/dt = 200A/µs, V _R = 100V	Qrr	40	-	nC
Reverse recovery time		t _{rr}	20	-	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
PUAD6xCH	ThinDPAK	4,500 / Tape & Reel		

Notes:

1. "x" defines voltage from 100V(PUAD6BCH) to 200V(PUAD6DCH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

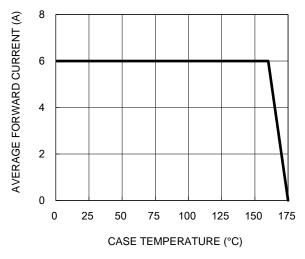


Fig.3 Typical Reverse Characteristics

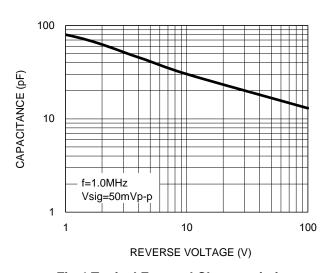
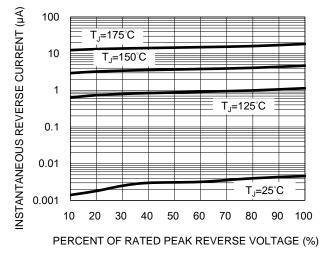


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



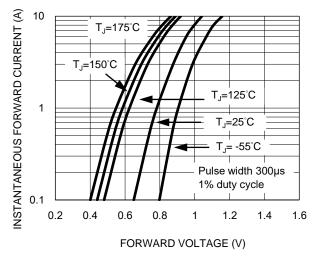
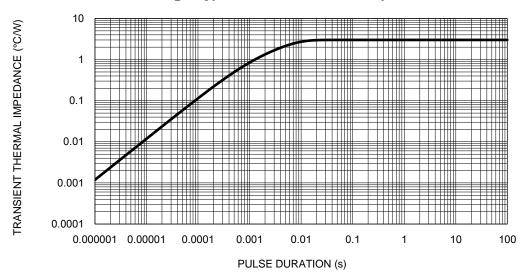


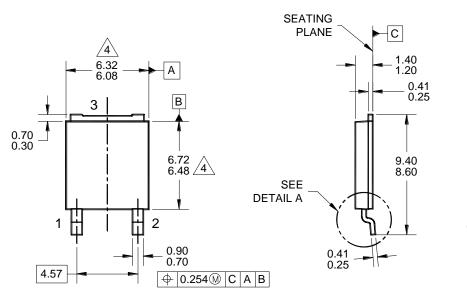
Fig.5 Typical Transient Thermal Impedance

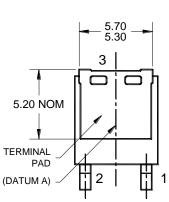


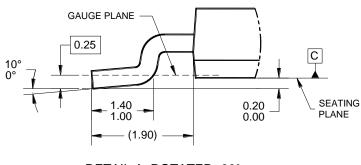


PACKAGE OUTLINE DIMENSIONS

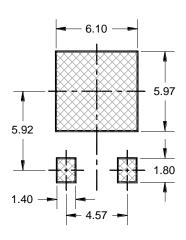
ThinDPAK



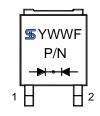




DETAIL A, ROTATED -90° (SCALE 4:1)



SUGGESTED PAD LAYOUT



MARKING DIAGRAM

YWW = DATE CODE F = FACTORY CODE

P/N = MARKING CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-252, VARIATION AE, ISSUE F.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURRS.
- 5. DWG NO. REF: HQ2SD07-TDPAK-065 REV A.



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